Silicon N-Channel Dual Gate MOS FET

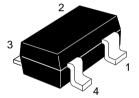
HITACHI

Application

VHF/UHF TV tuner RF amplifier

Outline

MPAK-4



- 1. Source
- 2. Gate1
- 3. Gate2
- 4. Drain



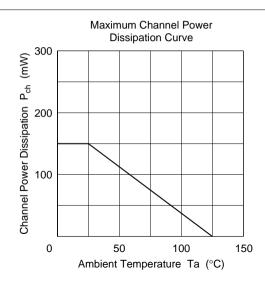
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

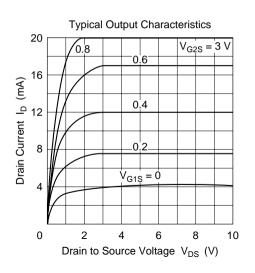
Item	Symbol	Ratings	Unit	
Drain to source voltage	V_{DS}	15	V	
Gate 1 to source voltage	V_{G1S}	±10	V	
Gate 2 to source voltage	$V_{\sf G2S}$	±10	V	
Drain current	I _D	35	mA mW	
Channel power dissipation	Pch	150		
Channel temperature	Tch	125	°C	
Storage temperature	Tstg	-55 to +125	°C	

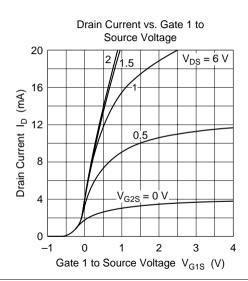
Electrical Characteristics ($Ta = 25^{\circ}C$)

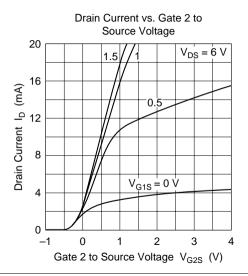
voltage	(BK)G133	15 ±10 ±10	-	_	V	$I_D = 200 \mu A,$ $V_{G1S} = V_{G2S} = -5 V$
			_	_		
	(BR)G2SS	±10			V	$I_{G1} = \pm 10 \ \mu A, \ V_{G2S} = V_{DS} = 0$
Gate 2 to source breakdown $V_{(\epsilon)}$ voltage		±10	_	_	V	$I_{G2} = \pm 10 \ \mu A, \ V_{G1S} = V_{DS} = 0$
Gate 1 cutoff current I _{G1}	188	_	_	±100	nA	$V_{G1S} = \pm 8 \text{ V}, V_{G2S} = V_{DS} = 0$
Gate 2 cutoff current I _{G2}	2SS	_	_	±100	nA	$V_{G2S} = \pm 8 \text{ V}, V_{G1S} = V_{DS} = 0$
Gate 1 to source cutoff voltage V _c	G1S(off)	_	-	-1.0	V	$V_{DS} = 10 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 100 \mu\text{A}$
Gate 2 to source cutoff voltage V _c	G2S(off)	_	_	-1.5	V	$V_{DS} = 10 \text{ V}, V_{G1S} = 3 \text{ V},$ $I_{D} = 100 \mu\text{A}$
Drain current I _{DS}	SS	0	_	10	mA	$V_{DS} = 6 \text{ V}, V_{G1S} = 0, V_{G2S} = 3 \text{ V}$
Forward transfer admittance y,	fs	17	_	_	mS	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 1 \text{ kHz}$
Input capacitance Ci	iss	_	2.8	3.5	pF	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 1 \text{ MHz}$
Output capacitance Co	oss	_	1.8	2.5	pF	
Reverse transfer capacitance Cr	rss		0.02	_	pF	
Power gain PC	G	12	15	_	dB	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 900 \text{ MHz}$
Noise figure NF	F	_	3.0	4.5	dB	
Noise figure NF	F	_	3.0	4.0	dB	$V_{DD} = 12 \text{ V}, V_{AGC} = 10.5 \text{ V},$ f = 60 MHz
Power gain PC	G	27	30	_	dB	$V_{DS} = 6 \text{ V}, V_{G2S} = 3 \text{ V},$ $I_{D} = 10 \text{ mA}, f = 200 \text{ MHz}$
Noise figure NF	F	_	1.0	2.5	dB	

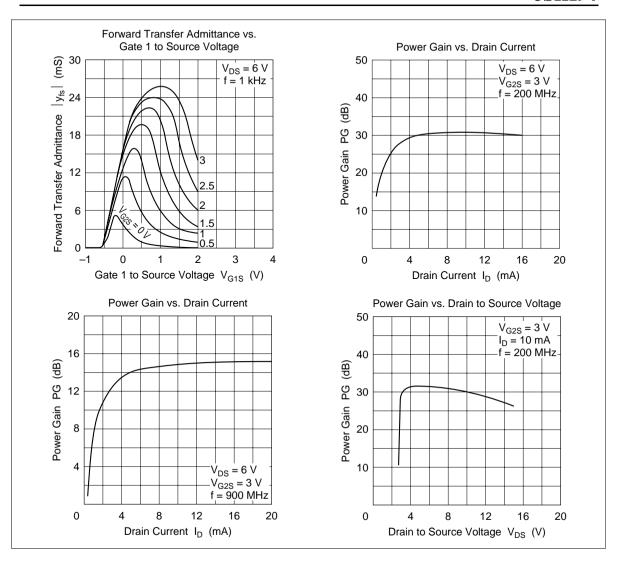
Note: Marking is "IY-".

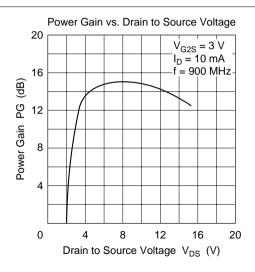


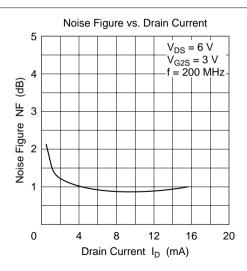


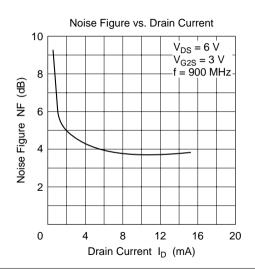


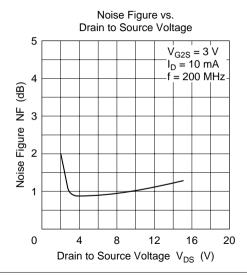


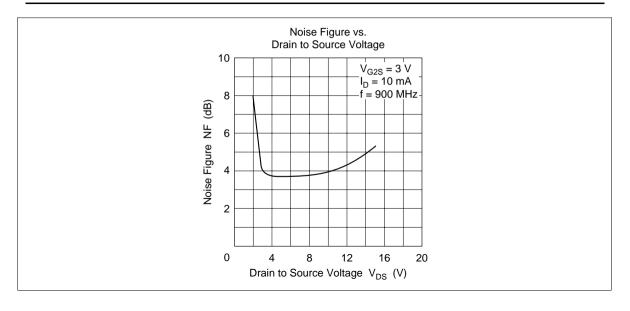




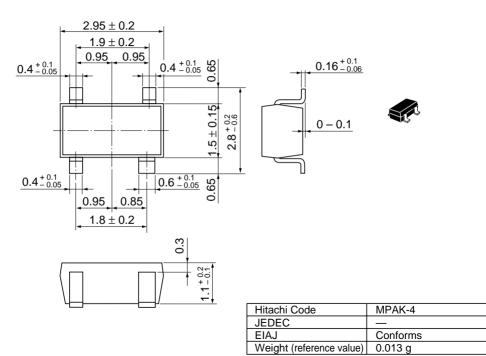








Unit: mm



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